

LEADED

BGA SOLDER PASTE

● ● ●
Sn63/Pb37

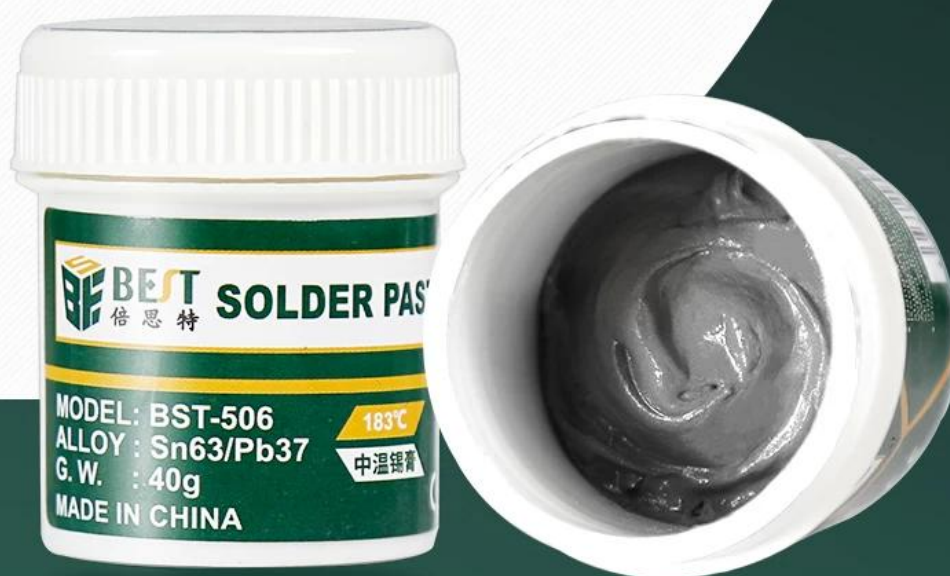
Melting point 183°C



Product Usage

● ● ●
TIN PASTE

Type number	BST-506
Types of	Solder Paste
Composition	Sn63/Pb37
Melting point	183℃
G.W.	40g
size	38*32mm

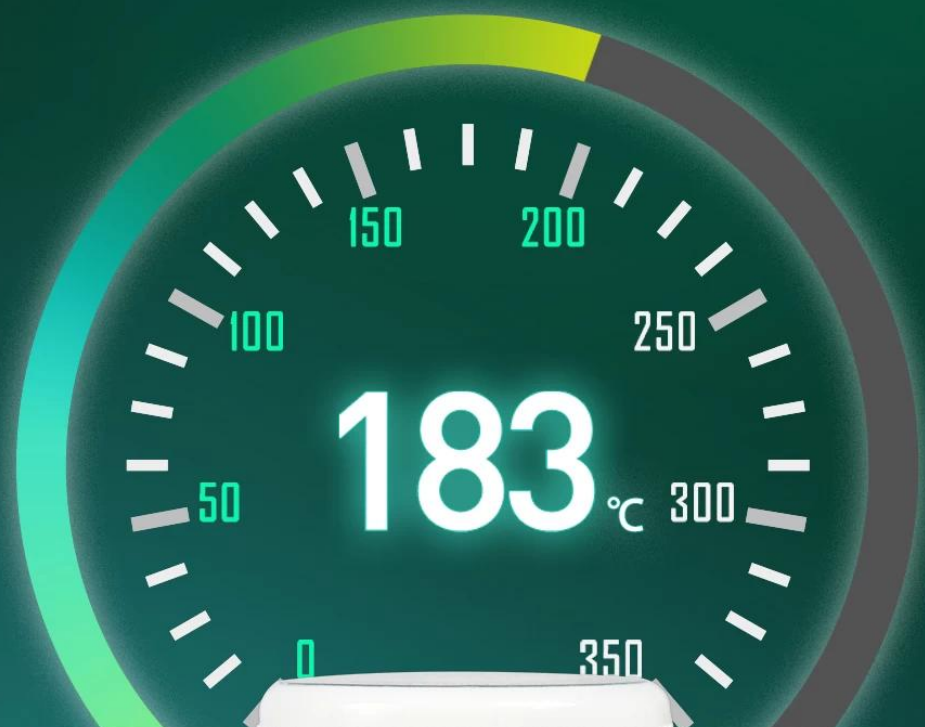


Sn63/Pb37

Melting point at medium temperature

183°C

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Low residue



Solder spot bright



Rapid welding

Welding requirements for a wide range of products



SMT
patch



LED
patch



BGA
welding



Product List

G.W.:40g

